

Electronic Acknowledgement Receipt

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Title of Invention:	System and method for sharing confidential semiconductor manufacturing information using transitory links
First Named Inventor/Applicant Name:	Cheng-Hui Chiu
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part /.zip	Pages (if appl.)
1	Amendment - After Non-Final Rejection	85Response.pdf	313777	no	9

Warnings:

Information:	
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